





#### N-CHANNEL ENHANCEMENT MODE MOSFET PLUS PNP TRANSISTOR

#### **Features**

- N-Channel MOSFET and PNP Transistor in One Package
- Low On-Resistance
- Very Low Gate Threshold Voltage, 1.0V max
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Lead, Halogen and Antimony Free, RoHS Compliant (Note 2)
- ESD Protected MOSFET Gate up to 2kV
- "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: SOT-563
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 5
- Ordering Information: See Page 5
- Weight: 0.006 grams (approximate)

SOT-563



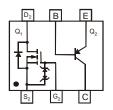




TOP VIEW



**BOTTOM VIEW** 



TOP VIEW Internal Schematic

### Maximum Ratings – MOSFET, Q1 @TA = 25°C unless otherwise specified

Characteri	stic	Symbol	Value	Units
Drain-Source Voltage		$V_{DSS}$	50	V
Gate-Source Voltage		$V_{GSS}$	±12	V
Drain Current (Note 1)	Continuous	I <sub>D</sub>	160	mA
Pulsed Drain Current (Note 1)		I <sub>DM</sub>	560	mA

#### Maximum Ratings - PNP Transistor, Q2 @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-50	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-45	V
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0	V
Collector Current	Ic	-100	mA

#### Thermal Characteristics, Total Device @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 1)	P <sub>D</sub>	250	mW
Thermal Resistance, Junction to Ambient (Note 1)	$R_{ hetaJA}$	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Notes:

- 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 2. No purposefully added lead. Halogen and Antimony Free.
- 3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.



# Electrical Characteristics - MOSFET @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 2)	-					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	50	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	10	μΑ	$V_{DS} = 50V$ , $V_{GS} = 0V$
Gate-Body Leakage	I <sub>GSS</sub>	_	_	1.0 5.0	μА	$V_{GS} = \pm 8V, V_{DS} = 0V$ $V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 2)						
Gate Threshold Voltage	$V_{GS(th)}$	0.7	0.8	1.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance		_	3.1	4	Ω	$V_{GS} = 4V, I_{D} = 100mA$
Static Drain-Source On-Resistance	R <sub>DS</sub> (ON)	_	4	5		$V_{GS} = 2.5V, I_D = 80mA$
Forward Transconductance	g <sub>FS</sub>	180	_	_	mS	$V_{DS} = 10V, I_D = 100mA,$ f = 1.0KHz
DYNAMIC CHARACTERISTICS						
Input Capacitance	C <sub>iss</sub>	_	25	_	pF	101/1/
Output Capacitance	Coss		5		pF	$V_{DS} = 10V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	2.1	_	pF	TI = 1.0IVII IZ

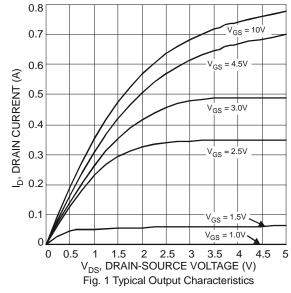
### Electrical Characteristics - PNP Transistor @TA = 25°C unless otherwise specified

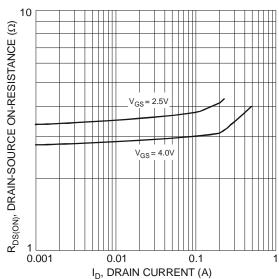
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage (Note 4)	V <sub>(BR)CBO</sub>	-50	_	_	V	$I_C = 10\mu A, I_B = 0$
Collector-Emitter Breakdown Voltage (Note 4)	V <sub>(BR)CEO</sub>	-45			V	$I_C = 10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage (Note 4)	V <sub>(BR)EBO</sub>	-5	_	_	V	$I_E = 1 \mu A, I_C = 0$
DC Current Gain (Note 4)	h <sub>FE</sub>	220	290	475	l	$V_{CE} = -5.0V, I_{C} = -2.0mA$
Collector-Emitter Saturation Voltage (Note 4)	V <sub>CE(SAT)</sub>	_	_	-100 -400	mV	$I_C = -10$ mA, $I_B = -0.5$ mA $I_C = -100$ mA, $I_B = -5.0$ mA
Base-Emitter Saturation Voltage (Note 4)	V <sub>BE(SAT)</sub>		-700 -900		mV	$I_C = -10$ mA, $I_B = -0.5$ mA $I_C = -100$ mA, $I_B = -5.0$ mA
Base-Emitter Voltage (Note 4)	V <sub>BE(ON)</sub>	-600 —		-750 -820	mV	$V_{CE} = -5.0V, I_{C} = -2.0mA$ $V_{CE} = -5.0V, I_{C} = -10mA$
Collector-Cutoff Current (Note 4)	I <sub>CBO</sub>	_	_	-15 -4.0	nΑ μΑ	$V_{CB} = -30V$ $V_{CB} = -30V$ , $T_{A} = 150^{\circ}C$
Collector-Emitter Cut-Off Current (Note 4)	I <sub>CES</sub>	_	_	-100	nA	V <sub>CE</sub> = -45V
Gain Bandwidth Product	f <sub>T</sub>	100			MHz	$V_{CE} = -5.0V$ , $I_{C} = -10mA$ , $f = 100MHz$
Output Capacitance	Сов		_	4.5	pF	V <sub>CB</sub> = -10V, f = 1.0MHz
Noise Figure	NF	_	_	10	dB	$I_{C}$ = -0.2mA, $V_{CE}$ = -5.0Vdc, R <sub>S</sub> = 2.0K $\Omega$ , f = 1.0KHz, BW = 200Hz

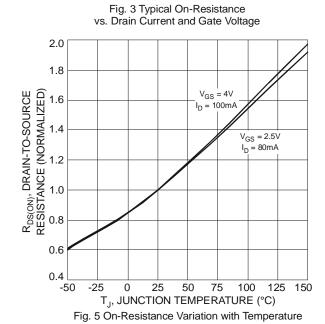
Notes: 4. Short duration pulse test used to minimize self-heating effect.

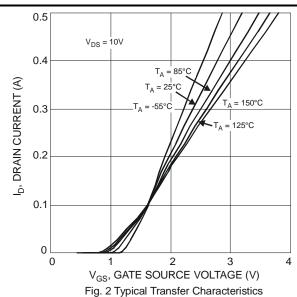


### **MOSFET**









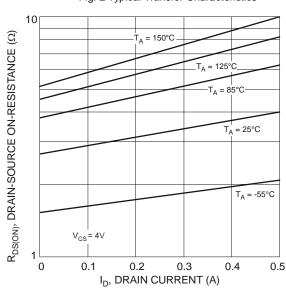
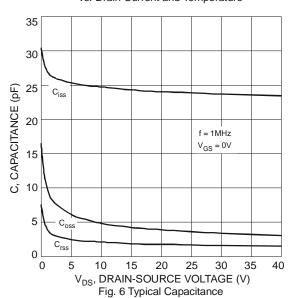


Fig. 4 Typical Drain-Source On-Resistance vs. Drain Current and Temperature





## **MOSFET** (continued)

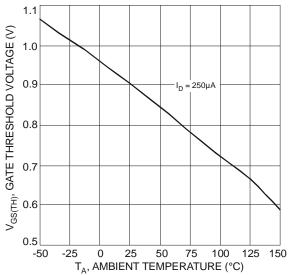


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

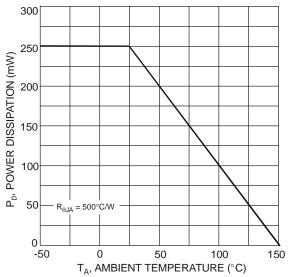
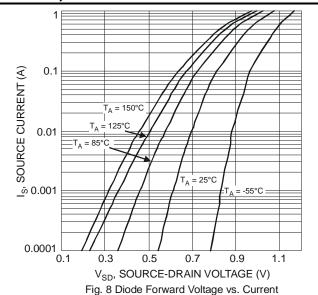


Fig. 9 Derating Curve - Total Package Power Dissipation





## **PNP Transistor**

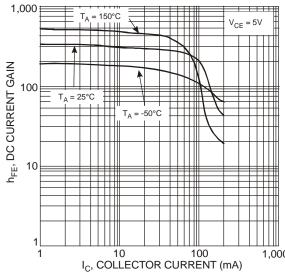


Fig. 10 Typical DC Current Gain vs. Collector Current

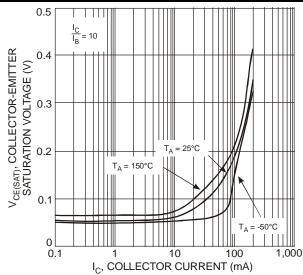


Fig. 11 Collector-Emitter Saturation Voltage vs. Collector Current

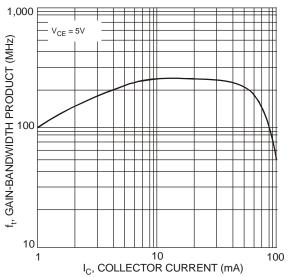


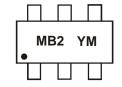
Fig. 12 Typical Gain-Bandwidth Product vs. Collector Current

### Ordering Information (Note 5)

Part Number	Case	Packaging		
DMB54D0UV-7	SOT-563	3000/Tape & Reel		

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**



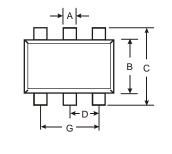
MB2 = Marking Code YM = Date Code Marking Y = Year (ex: V = 2008) M = Month (ex: 9 = September)

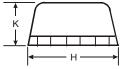
Date Code Key

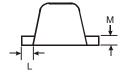
Year	2008		2009	2010		2011	2012		2013	2014		2015
Code	V		W	X		Υ	Z		Α	В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Au	g Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



## **Package Outline Dimensions**

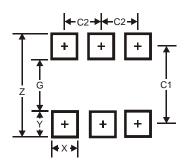






	SOT-563								
Dim	Min	Max	Тур						
Α	0.15	0.30	0.20						
В	1.10	1.25	1.20						
С	1.55	1.70	1.60						
D	-	-	0.50						
G	0.90	1.10	1.00						
Н	1.50	1.70	1.60						
K	0.55	0.60	0.60						
L	0.10	0.30	0.20						
M	0.10	0.18	0.11						
All	All Dimensions in mm								

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Υ	0.5
C1	1.7
C2	0.5



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